

P54/74FCT543/A (P54/74PCT543/A) P54/74FCT544/A (P54/74PCT544/A) OCTAL REGISTERED TRANSCEIVER

★ FEATURES

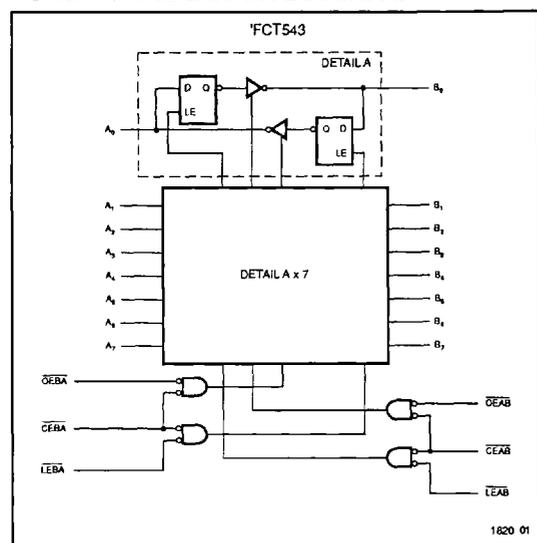
- Function, Pinout, and Drive Compatible with the FCT and F Logic
- FCT-A speed at 6.5ns max. (Com'I)
FCT speed at 8.5ns max. (Com'I)
- CMOS V_{OH} Levels for Low Power Consumption
— Typically 1/3 of FAST Bipolar Logic
- Edge-rate Control Circuitry for Significantly Improved Noise Characteristics
- ESD protection exceeds 2000V
- Inputs and Outputs Interface Directly with TTL, NMOS, and CMOS Devices
- Outputs Meet Levels Required for CMOS Static RAM Low Power Standby Mode
- 64 mA Sink Current (Com'I), 48 mA (Mil)
15 mA Source Current (Com'I), 12 mA (Mil)
- Separate Controls for Data Flow in Each Direction
- Back to Back Latches for Storage
- 3-State Output
- Manufactured in 0.8 micron PACE Technology™

★ DESCRIPTION

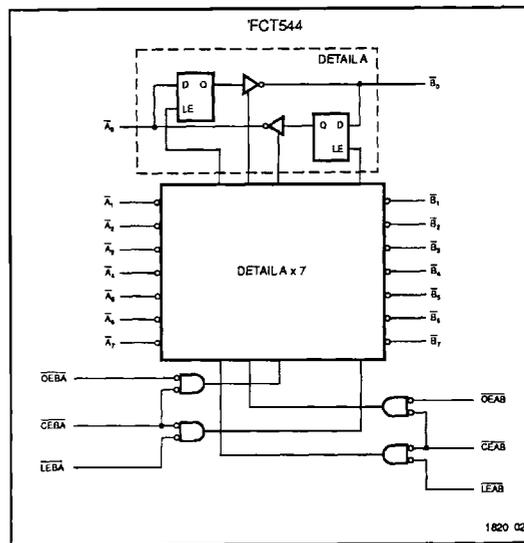
The 'FCT543 and 'FCT544 Octal Registered Transceivers contain two sets of eight D-type latches with separate Latch Enable (\overline{LEAB} , \overline{LEBA}) and Output Enable (\overline{OEAB} , \overline{OEBA}) controls for each set to permit independent control of inputting and outputting in either direction of data flow. For data flow from A to B, for example, the A-to-B Enable (\overline{CEAB}) input must be LOW in order to enter data from A0–A7 or to take data from B0–B7, as indicated in the truth table. With \overline{CEAB} LOW, a LOW signal on the A-to-B Latch

Enable (\overline{LEAB}) input makes the A-to-B latches transparent; a subsequent LOW-to-HIGH transition of the \overline{LEAB} signal puts the A latches in the storage mode and their output no longer change with the A inputs. With \overline{CEAB} and \overline{OEAB} both LOW, the 3-state B output buffers are active and reflect the data present at the output of the A latches. Control of data from B to A is similar, but uses \overline{CEAB} , \overline{LEAB} and \overline{OEAB} inputs.

★ FUNCTIONAL BLOCK DIAGRAM

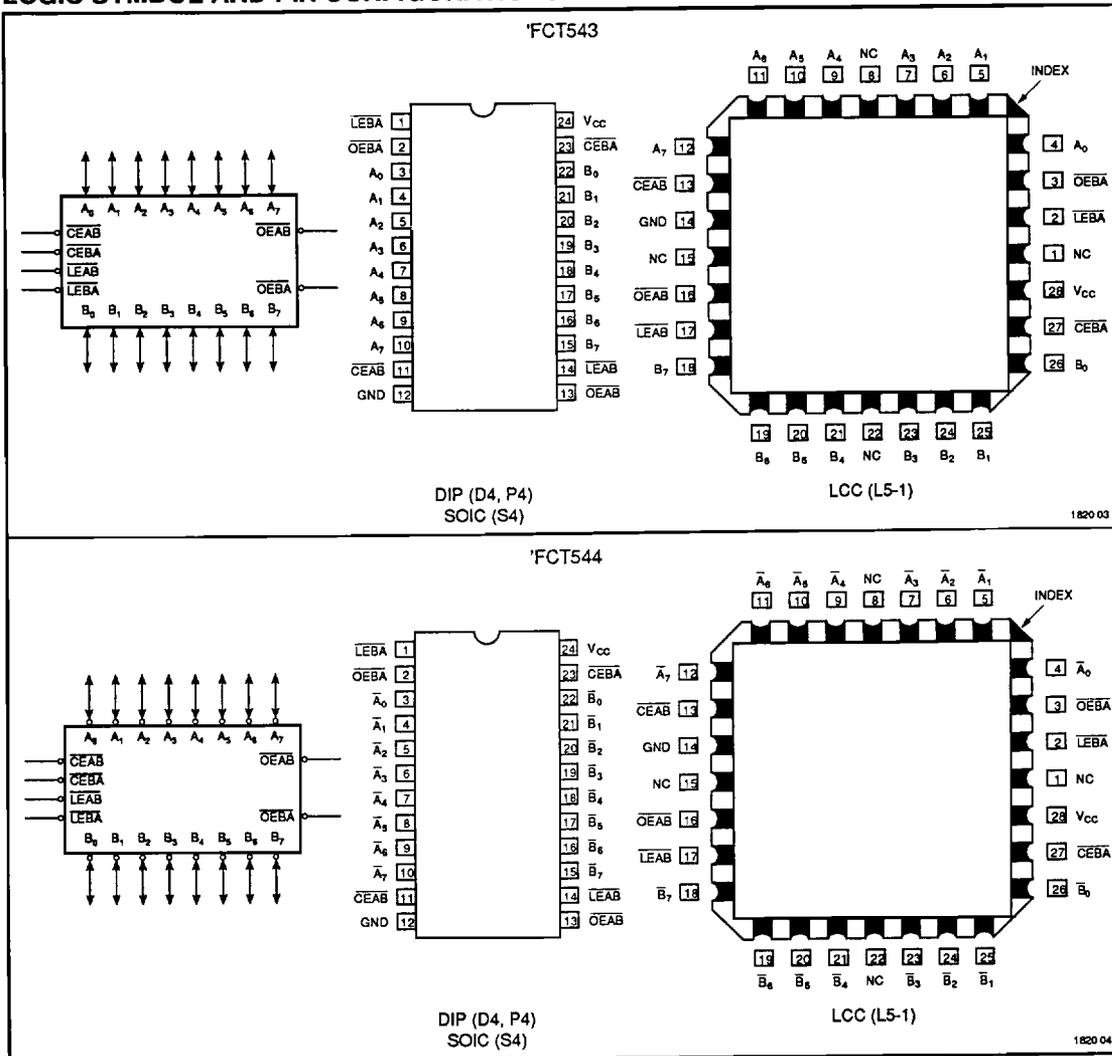


FUNCTIONAL BLOCK DIAGRAM



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LOGIC SYMBOL AND PIN CONFIGURATIONS



PIN DESCRIPTIONS

Pin Name	Description
\overline{OEAB}	A-to-B Output Enable Input (Active LOW)
\overline{OEBA}	B-to-A Output Enable Input (Active LOW)
\overline{CEAB}	A-to-B Enable Input (Active LOW)
\overline{CEBA}	B-to-A Enable Input (Active LOW)
\overline{LEAB}	A-to-B Latch Enable Input (Active LOW)
\overline{LEBA}	B-to-A Latch Enable Input (Active LOW)
A_0 – A_7	A-to-B Data Inputs or B-to-A 3-State Outputs
B_0 – B_7	B-to-A Data Inputs or A-to-B 3-State Outputs

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ABSOLUTE MAXIMUM RATINGS^{1,2}

Symbol	Parameter	Value	Unit
T_{STG}	Storage Temperature	-65 to +150	°C
T_A	Ambient Temperature Under Bias	-65 to +135	°C
V_{CC}	V_{CC} Potential to Ground	-0.5 to +7.0	V
I_{IN}	Input Current	-30 to +5.0	mA

Notes:

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1. Operation beyond the limits set forth in the above table may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.

RECOMMENDED OPERATING CONDITIONS

Free Air Ambient Temperature	Min	Max
Military	-55°C	+125°C
Commercial	0°C	+70°C

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Symbol	Parameter	Value	Unit
I_{OUTPUT}	Current Applied to Output	120	mA
V_{IN}	Input Voltage	-0.5 to $V_{CC} + 0.5$	V
V_{OUT}	Voltage Applied to Output	-0.5 to $V_{CC} + 0.5$	V

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2. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.

Supply Voltage (V_{CC})	Min	Max
Military	+4.5V	+5.5V
Commercial	+4.75V	+5.25V

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DC ELECTRICAL CHARACTERISTICS (Over recommended operating conditions)

Symbol	Parameter	Min	Typ ¹	Max	Units	V_{CC}	Conditions	
V_{IH}	Input HIGH Voltage	2.0			V			
V_{IL}	Input LOW Voltage		0.8	V				
V_H	Hysteresis		0.35		V		All inputs	
V_{CD}	Input Clamp Diode Voltage		-0.7	-1.2	V	MIN	$I_{IN} = -18\text{mA}$	
V_{OH}	Output HIGH Voltage	$V_{CC} = 3\text{V}, V_{IN} = 0.2\text{V}, \text{ or } V_{CC} - 0.2\text{V}$	$V_{CC} - 0.2$	V_{CC}	V		$I_{OH} = -32\mu\text{A}$	
		Military/Commercial (CMOS)	$V_{CC} - 0.2$	V_{CC}	V	MIN	$I_{OH} = -300\mu\text{A}$	
		Military (TTL)	2.4	4.3	V	MIN	$I_{OH} = -12\text{mA}$	
		Commercial (TTL)	2.4	4.3	V	MIN	$I_{OH} = -15\text{mA}$	
V_{OL}	Output LOW Voltage	$V_{CC} = 3\text{V}, V_{IN} = 0.2\text{V}, \text{ or } V_{CC} - 0.2\text{V}$		GND	0.2	V	$I_{OL} = 300\mu\text{A}$	
		Military/Commercial (CMOS)		GND	0.2	V	MIN	$I_{OL} = 300\mu\text{A}$
		Military (TTL)		0.3	0.55	V	MIN	$I_{OL} = 48\text{mA}$
		Commercial (TTL)		0.3	0.55	V	MIN	$I_{OL} = 64\text{mA}$
I_{IH}	Input HIGH Current (Except I/O Pins)			5	μA	MAX	$V_{IN} = V_{CC}$	
I_{IL}	Input LOW Current (Except I/O Pins)			-5	μA	MAX	$V_{IN} = \text{GND}$	
I_{IH}^3	Input HIGH Current ³ (Except I/O Pins)			5	μA	MAX	$V_{IN} = 2.7\text{V}$	
I_{IL}^3	Input LOW Current ³ (Except I/O Pins)			-5	μA	MAX	$V_{IN} = 0.5\text{V}$	
I_{IH}	Input HIGH Current (I/O Pins only)			15	μA	MAX	$V_{IN} = V_{CC}$	
I_{IL}	Input LOW Current (I/O Pins only)			-15	μA	MAX	$V_{IN} = \text{GND}$	
I_{IH}^3	Input HIGH Current ³ (I/O Pins only)			15	μA	MAX	$V_{IN} = 2.7\text{V}$	
I_{IL}^3	Input LOW Current ³ (I/O Pins only)			-15	μA	MAX	$V_{IN} = 0.5\text{V}$	
I_{OS}	Output Short Circuit Current ²	-60	-120		mA	MAX	$V_{OUT} = 0.0\text{V}$	
C_{IN}	Input Capacitance ³		5	10	pF		All inputs	
C_{OUT}	Output Capacitance ³		9	12	pF		All outputs	

Notes:

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1. Typical limits are at $V_{CC} = 5.0\text{V}$, $T_A = +25^\circ\text{C}$ ambient.
 2. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect

operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

3. This parameter is guaranteed but not tested.

DC CHARACTERISTICS (Over recommended operating conditions unless otherwise specified.)

Symbol	Parameter	Typ. ¹	Max.	Units	Conditions
I_{CC}	Quiescent Power Supply Current (CMOS inputs)	0.003	0.5	mA	$V_{CC} = \text{MAX}$, $f_1 = 0$, Outputs Open, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
ΔI_{CC}	Quiescent Power Supply Current (TTL inputs)	0.5	2.0	mA	$V_{CC} = \text{MAX}$, $V_{IN} = 3.4V^2$, $f_1 = 0$, Outputs Open
I_{CCD}	Dynamic Power Supply Current ³	0.15	0.25	mA/ mHz	$V_{CC} = \text{MAX}$, One Input Toggling, 50% Duty Cycle, $\overline{CEAB} + \overline{OEAB} = \text{Low}$, Outputs Open, $\overline{CEAB} = \text{High}$, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
I_C	Total Power Supply Current ⁵	1.7	4.0	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, $\overline{CEAB} + \overline{OEAB} = \text{Low}$ 50% Duty Cycle, Outputs Open, $\overline{CEBA} = \text{High}$ One Bit Toggling at $f_1 = 5\text{MHz}$, $f_0 = \overline{LEAB} = 10\text{MHz}$, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
		2.2	6.0	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, $\overline{CEAB} + \overline{OEAB} = \text{Low}$ 50% Duty Cycle, Outputs Open, $\overline{CEBA} = \text{High}$ One Bit Toggling at $f_1 = 5\text{MHz}$, $f_0 = \overline{LEAB} = 10\text{MHz}$, $V_{IN} = 3.4V$ or $V_{IN} = \text{GND}$
		7.0	12.8 ⁴	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, $\overline{CEAB} + \overline{OEAB} = \text{Low}$ 50% Duty Cycle, Outputs Open, $\overline{CEBA} = \text{High}$ Eight Bits Toggling at $f_1 = 5\text{MHz}$, $f_0 = \overline{LEAB} = 10\text{MHz}$, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
		9.2	21.8 ⁴	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, $\overline{CEAB} + \overline{OEAB} = \text{Low}$ 50% Duty Cycle, Outputs Open, $\overline{CEBA} = \text{High}$ Eight Bits Toggling at $f_1 = 5\text{MHz}$, $f_0 = \overline{LEAB} = 10\text{MHz}$, $V_{IN} = 3.4V$ or $V_{IN} = \text{GND}$

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Notes:

- Typical values are at $V_{CC} = 5.0V$, +25°C ambient.
- Per TTL driven input ($V_{IN} = 3.4V$); all other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
- Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
- $I_C = I_{\text{QUIESCENT}} + I_{\text{INPUTS}} + I_{\text{DYNAMIC}}$
 $I_C = I_{CC} + \Delta I_{CC} D_n N_T + I_{CCD} (f_0/2 + f_1 N_i)$
 $I_{CC} = \text{Quiescent Current with CMOS input levels}$

$\Delta I_{CC} =$ Power Supply Current for a TTL High Input ($V_{IN} = 3.4V$)

$D_n =$ Duty Cycle for TTL Inputs High

$N_T =$ Number of TTL Inputs at D_n

$I_{CCD} =$ Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

$f_0 =$ Clock Frequency for Register Devices (Zero for Non-Register Devices)

$f_1 =$ Input Frequency

$N_i =$ Number of Inputs at f_1

All currents are in milliamps and all frequencies are in megahertz.

TRUTH TABLE FOR A-TO-B (Symmetric with B-to-A)

Inputs			Latch Status	Outputs 'FCT543	Outputs 'FCT544
CEAB	LEAB	OEAB	A-TO-B	B0-B7	B0-B7
H	-	-	Storing	High Z	High Z
-	H	-	Storing	-	-
-	-	H	-	High Z	High Z
L	L	L	Transparent	Current A Inputs	Previous A Inputs
L	H	L	Storing	Previous A Inputs	Current A Inputs

* = Before \overline{LEAB} LOW-to-HIGH Transition

H = HIGH Voltage Level

L = LOW Voltage Level

- = Don't Care or Irrelevant

A-to-B data flow shown: B-to-A flow control is the same, except using \overline{CEBA} , \overline{LEBA} , and \overline{OEBA}

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AC CHARACTERISTICS

Sym.	Parameter	'FCT543 'FCT544				'FCT543A 'FCT544A				Units	Fig. No.
		MIL		COM'L		MIL		COM'L			
		Min. ¹	Max.	Min. ¹	Max.	Min. ¹	Max.	Min. ¹	Max.		
t _{PLH} t _{PHL}	Propagation Delay Transparent Mode A _n to B _n or B _n to A _n	2.0	10.0	2.5	8.5	2.5	7.5	2.5	6.5	ns	1, 5
t _{PLH} t _{PHL}	Propagation Delay LEBA to A _n LEAB to B _n	2.5	14.0	2.5	12.5	2.5	9.0	2.5	8.0	ns	1, 5
t _{PZH} t _{PZL}	Output Enable Time OEBA or OEAB to A _n or B _n CEBA or CEAB to A _n or B _n	2.0	14.0	2.0	12.0	2.0	10.0	2.0	9.0	ns	1,7,8
t _{PHZ} t _{PLZ}	Output Disable Time OEBA or OEAB to A _n or B _n CEBA or CEAB to A _n or B _n	2.0	13.0	2.0	9.0	2.0	8.5	2.0	7.5	ns	1,7,8

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Note: Minimum limits are guaranteed on Propagation Delays.

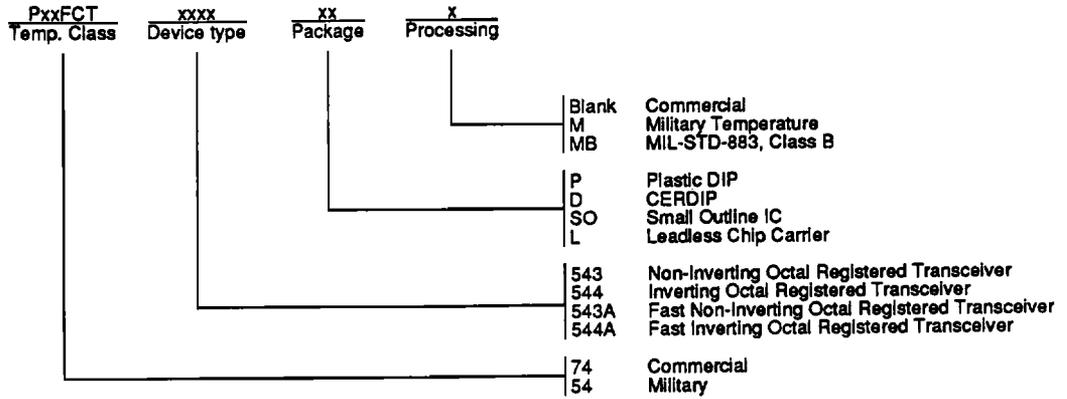
AC OPERATING REQUIREMENTS

Sym.	Parameter	'FCT543 'FCT544				'FCT543A 'FCT544A				Units	Fig. No.
		MIL		COM'L		MIL		COM'L			
		Min. ¹	Max.	Min. ¹	Max.	Min. ¹	Max.	Min. ¹	Max.		
t _s (H) t _s (L)	Set-up Time HIGH or LOW A _n or B _n to LEBA or LEAB	3.0	—	3.0	—	2.0	—	2.0	—	ns	9
t _h (H) t _h (L)	Hold Time HIGH or LOW A _n or B _n to LEBA or LEAB	2.0	—	2.0	—	2.0	—	2.0	—	ns	9
t _w	LEBA or LEAB Pulse Width LOW	5.0	—	5.0	—	5.0	—	5.0	—	ns	6

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ORDERING INFORMATION



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